

PCN Number:	20211129002.2		PCN Date:	December 03, 2021
Title:	Adding CD-PR as additional wafer probe site			
Customer Contact:	PCN Manager		Dept:	Quality Services
Proposed 1st Ship Date:	June 03, 2022	Estimated Sample Availability:	Samples not supported	
Change Type:				
<input type="checkbox"/>	Assembly Site	<input type="checkbox"/>	Design	<input type="checkbox"/>
<input type="checkbox"/>	Assembly Process	<input type="checkbox"/>	Data Sheet	<input type="checkbox"/>
<input type="checkbox"/>	Assembly Materials	<input type="checkbox"/>	Part number change	<input type="checkbox"/>
<input type="checkbox"/>	Mechanical Specification	<input checked="" type="checkbox"/>	Test Site	<input type="checkbox"/>
<input type="checkbox"/>	Packing/Shipping/Labeling	<input type="checkbox"/>	Test Process	<input type="checkbox"/>
		<input type="checkbox"/>	Wafer Bump Site	
		<input type="checkbox"/>	Wafer Bump Material	
		<input type="checkbox"/>	Wafer Bump Process	
		<input type="checkbox"/>	Wafer Fab Site	
		<input type="checkbox"/>	Wafer Fab Materials	
		<input type="checkbox"/>	Wafer Fab Process	
PCN Details				
Description of Change:				
Texas Instruments Incorporated has qualified CD-PR as an additional probe site for the devices listed below to support high volume ramps.				
Current:		New:		
Probe Site	TIEM-PR	TI Chengdu (CD-PR)		
Test coverage, insertions, conditions will remain consistent with current testing.				
Reason for Change:				
Enable additional probe capacity to support high volume ramps.				
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):				
None.				
Changes to product identification resulting from this PCN:				
None.				
Product Affected:				
LM5160QPWPQ1	LM5160QPWPRQ1	LM5160QPWPTQ1		

For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
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WW PCN Team	PCN_ww_admin_team@list.ti.com

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